

# DIN-Power Flow048FP-4,5C1-2



Part number	09 06 248 6832	
Specification	DIN-Power Flow048FP-4,5C1-2	
HARTING eCatalogue	https://b2b.harting.com/09062486832	

Image is for illustration purposes only. Please refer to product description.

# Identification

Category	Connectors
Series	DIN 41612
Identification	Type F
Element	Female connector
Description of the contact	Straight
Features	lead-free

#### Version

Termination method	Press-in termination	
Termination method	FIESS-III LETTIIII I I ILIIII	
Connection type	Motherboard to daughtercard  Mezzanine	
	wezzanne	
Number of contacts	48	
Contact configuration	Rows z, d and b, positions 2, 4,, 30, 32	
Termination length	4.5 mm	
	Hole coding	
Coding	Coding with loss of contacts	
	D20 coding	
	Shroud coding	
PCB fixing	With fixing flange	

# Technical characteristics

Contact rows	3
Contact spacing (termination side)	3.81 mm
	5.08 mm



# Technical characteristics

Contact spacing (mating side)	3.81 mm	
	5.08 mm	
Rated current	6 A	
Rated current	Rated current measured at 20 °C, see derating curve for details	
Clearance distance	≥1.6 mm	
Creepage distance	≥3 mm	
Insulation resistance	>10 <sup>12</sup> Ω	
Contact resistance	≤15 mΩ	
Limiting temperature	-40 +105 °C upper limiting temperature limited by the pcb	
. <b>3</b>		
Insertion and withdrawal force	≤75 N	
Insertion and withdrawal force		
	≤75 N	
Insertion and withdrawal force	≤75 N 2	
Insertion and withdrawal force Performance level Mating cycles	≤75 N 2 acc. to IEC 60603-2	
Insertion and withdrawal force Performance level	≤75 N  2 acc. to IEC 60603-2 ≥400	
Insertion and withdrawal force Performance level Mating cycles	≤75 N  2 acc. to IEC 60603-2 ≥400  1.55 kV (contact-contact)	
Insertion and withdrawal force  Performance level  Mating cycles  Test voltage $U_{r,m,s}$ .	≤75 N  2 acc. to IEC 60603-2 ≥400  1.55 kV (contact-contact) 2.5 kV (contact-ground)	
Insertion and withdrawal force  Performance level  Mating cycles  Test voltage U <sub>r.m.s.</sub> Isolation group	≤75 N  2 acc. to IEC 60603-2 ≥400  1.55 kV (contact-contact) 2.5 kV (contact-ground)  Illa (175 ≤ CTI < 400)	

# Material properties

Material (insert)	Thermoplastic resin, glass-fibre filled
Colour (insert)	RAL 7032 (pebble grey)
Material (contacts)	Copper alloy
Surface (contacts)	Noble metal over Ni Mating side Ni Termination side
Material flammability class acc. to UL 94	V-0
RoHS	compliant
ELV status	compliant
China RoHS	е
REACH Annex XVII substances	No
REACH ANNEX XIV substances	No
REACH SVHC substances	No
California proposition 65	Yes



# Material properties

California proposition 65 substances	Nickel
California proposition of substances	Antimony trioxide

## Specifications and approvals

Specifications	IEC 60603-2
UL / CSA	UL 1977 ECBT2.E102079 CSA-C22.2 No. 182.3 ECBT8.E102079
Railway classification	F4/I3 acc. to NFF 16-101/102

#### Commercial data

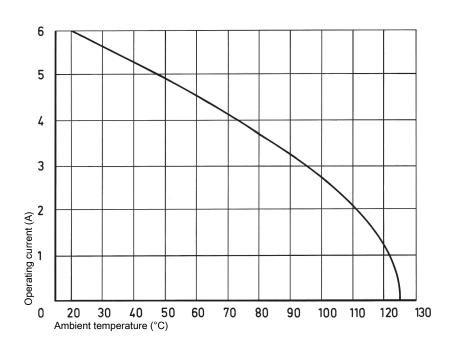
Packaging size	20
Net weight	13.34 g
Country of origin	Germany
European customs tariff number	85366990
eCl@ss	27460201 PCB connector (board connector)

# Current carrying capacity

The current carrying capacity of the connectors is limited by the thermal load capability of the contact element material including the connections and the insulating parts. The derating curve is therefore valid for currents which flow constantly (non-intermittent) through each contact element of the connector evenly, without exceeding the allowed maximum temperature.

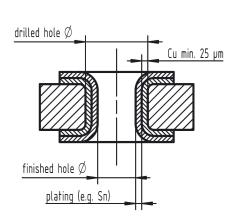
Measuring and testing techniques acc. to IEC.

Measuring and testing techniques acc. to IEC 60512-5-2





## Recommended configuration of plated through holes



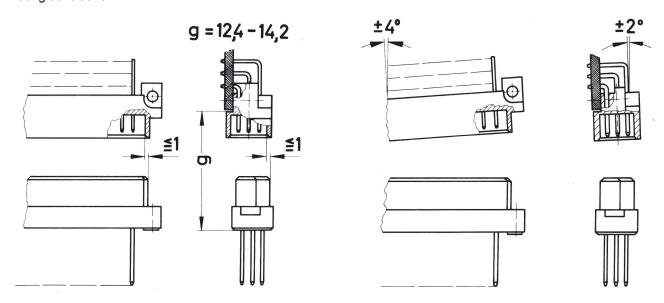
Tin plated PCB (HAL) acc. to EN 60352-5	Drilled hole Ø	1,15±0,025 mm
	Sn	max. 15 µm
acc. 10 EN 00332-3	plated hole $\emptyset$	0,94 - 1,09 mm
	Drilled hole Ø	1,15±0,025 mm
Chemical tin plated PCB	Sn	min. 0,8µm
	plated hole Ø	1,00 - 1,10 mm
Gold /Nickel plated PCB	Drilled hole Ø	1,15±0,025 mm
	Ni	3 – 7 µm
	Au	0,05 - 0,12 µm
	plated hole Ø	1,00 - 1,10 mm
Silver plated PCB	Drilled hole Ø	1,15±0,025 mm
	Ag	0,1 - 0,3 µm
	plated hole Ø	1,00 - 1,10 mm
Copper plated PCB (OSP)	Drilled hole Ø	1,15±0,025 mm
	plated hole Ø	1,00 - 1,10 mm

In addition to the hot-air-level (HAL) other pcb surfaces are getting more important. Due to their different properties, such as mechanical strength and coefficient of friction we recommend the above mentioned configuration of pcb through holes.

#### Assembly instructions

It is highly recommended to use HARTING press-in tools to ensure a reliable press-in process. Please refer to the catalogue for tools, machines and further information for the press-in process.

### Mating conditions



To ensure reliable connections and prevent unnecessary damage, please refer to the application data diagrams. These recommendations are set out in IEC 60603-2.

The connectors should not be coupled and decoupled under electrical load.